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PATENT APPLICATION

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant(s): Katsuyuki TSUCHIDA et al

Title : COPPER ELECTROLYTIC SOLUTION CONTAINING AS ADDITIVE

COMPOUND HAVING SPECIFIC SKELETON, AND

ELECTROLYTIC COPPER FOIL MANUFACTURED THEREWITH

Serial No. : 10/588 686 Group: 1795

Confirmation No.: 9917

Filed : August 7, 2006 Examiner: Wong International Application No.: PCT/JP2005/022662
International Filing Date : December 9, 2005

Atty. Docket No.: 4700.P0335US

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

FIRST CLASS MAILING CERTIFICATE

Sir:

I hereby certify that this correspondence is being deposited with the United States Postal Service under 37 CFR 1.8 as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on January 20, 2009.

Terryence F. Chapman

TFC/ad

FLYNN, THIEL, BOUTELL David G. Boutell Reg. No. 25 072 & TANIS, P.C. Terryence F. Chapman Reg. No. 32 549 2026 Rambling Road Mark L. Maki Req. No. 36 589 Kalamazoo, MI 49008-1631 Reg. No. 40 694 Liane L. Churney Reg. No. 24 802 Phone: (269) 381-1156 John A. Waters (269) 381-5465 Brian R. Tumm Donald J. Wallace Fax: Reg. No. 36 328 Reg. No. 43 977 Dale H. Thiel Reg. No. 24 323 Sidney B. Williams, Jr. Reg. No. 24 949 Reg. No. L0379\* Heon Jekal \*limited recognition number

Correspondence: Supplemental Information Disclosure Statement dated

January 20, 2009 including enclosures listed

thereon

190.05/05



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SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Sir:

In compliance with the provisions of Rules 1.97(b)(3) and 1.98, enclosed herewith is a copy of a Japanese language Office Action issued in a corresponding application not more than three months prior to filing of this Information Disclosure Statement, Form PTO-1449 and a copy of a foreign reference cited thereon.

Further comment at this point in time should not be necessary.

Further consideration is respectfully solicited.

Respectfully submitted,

Terryerce F. Chapman

TFC/ad

& TANIS, P.C. 2026 Rambling Road Kalamazoo, MI 49008-1631 Phone: (269) 381-1156	David G. Boutell Terryence F. Chapman Mark L. Maki Liane L. Churney John A. Waters Brian R. Tumm Donald J. Wallace Dale H. Thiel Sidney B. Williams, Jr.	Reg. Reg. Reg. Reg. Reg. Reg.	No. No. No. No. No. No.	25 072 32 549 36 589 40 694 24 802 36 328 43 977 24 323 24 949
	Heon Jekal *limited recognition number	Reg.	No.	L0379*
	"TIMITED LECOCHITITION NUMBER			

Encl: Form PTO-1449

Copy of Japanese language Office Action One copy of cited foreign reference

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Terryepice F. Chapman

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